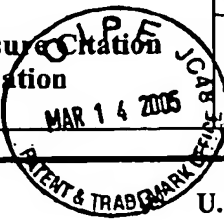


PTO-1449 Information Disclosure In an Application	Application No. 10/649,925		Applicant(s) Kovacevic et al.	
	Docket Number 021791.0109	Group Art Unit 2125	Filing Date 08/25/2003	



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	DOCUMENT NO.	DATE	NAME	CLASS	SUBCLASS	FILING DATE
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CK B	6,188,041	02/13/2001	Kim et al.	219	121.63	11/13/1998
CK C	6,311,099	10/30/2001	Jasper et al.	700	166	10/15/1998
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I						
J						
K						
L						
M						
N						

FOREIGN PATENT DOCUMENTS

	DOCUMENT NO.	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION	
						YES	NO
CK O		07/06/1999	Japan	B23K	26/02	XX	
CK P	WO 03/070414 A1	08/28/2003	PCT	B23K	26/03	XX	
Q							

	OTHER DOCUMENTS (Including Author, Title, Source, and Pertinent Pages)	DATE
R		
S		
T		

EXAMINER

DATE CONSIDERED

3/28/05

EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP § 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to the applicant.

U.S. PATENT AND TRADEMARK OFFICE

PTO-1449

Application No.

10/649,925

Applicant(s)

Kovacevic et al.

Information Disclosure
Citation
In an Application

Docket Number

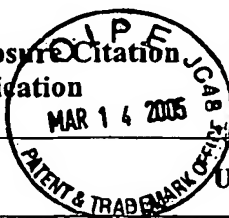
021791.0109

Group Art Unit

2125

Filing Date

Aug. 25, 2003



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CK	A	6,391,251	05/21/02	Keicher et al.	419	7	05/09/2000
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CK	E	B. Grünenwald et al., "New Technological Developments in Laser Cladding", Proceedings of the International Congress on Applications of Lasers and Electro-Optics (ICALEO 1993), pp. 934-944.					1993
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